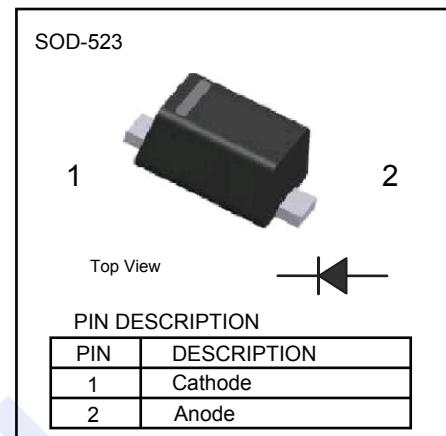


General Purpose PIN Diode

BAP51-02

■ Features

- Low diode capacitance
- Low diode forward resistance.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Min	Max	Unit
continuous reverse voltage	V _R		50	V
continuous forward current	I _F		50	mA
total power dissipation Ts = 90 °C	P _{tot}		715	mW
storage temperature	T _{stg}	-65	+150	°C
junction temperature	T _j	-65	+150	°C
thermal resistance from junction to soldering point	R _{th j-s}		85	K/W

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
forward voltage	V _F	I _F = 50 mA		0.95	1.1	V
reverse voltage	V _R	I _R = 10 μA	50			V
reverse current	I _R	V _R = 50 V			100	nA
diode capacitance	C _d	V _R = 0; f = 1 MHz		0.4		pF
		V _R = 1 V; f = 1 MHz		0.3	0.55	
		V _R = 5 V; f = 1 MHz		0.2	0.35	
diode forward resistance	R _D	I _F = 0.5 mA; f = 100 MHz; note 1		5.5	9	Ω
		I _F = 1 mA; f = 100 MHz; note 1		3.6	6.5	
		I _F = 10 mA; f = 100 MHz; note 1		1.5	2.5	

Note

1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

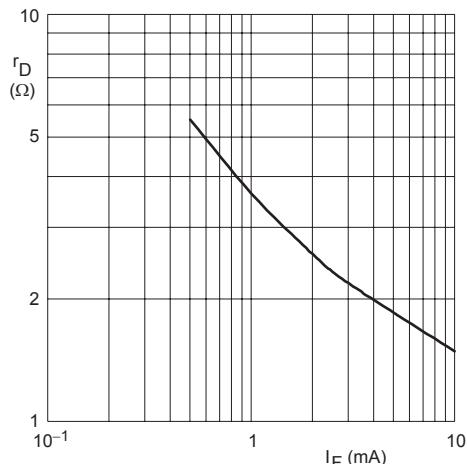
■ Marking

Marking	A5
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General Purpose PIN Diode

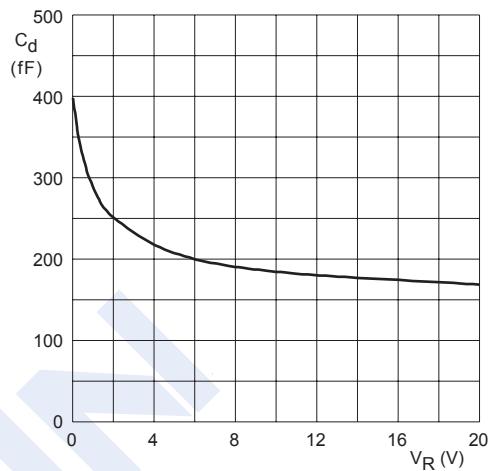
BAP51-02

■ Typical Characteristics



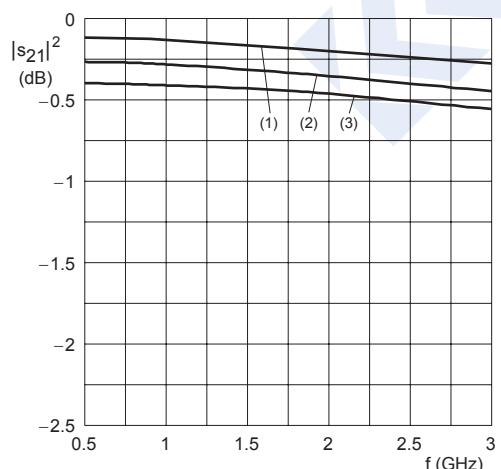
$f = 100 \text{ MHz}; T_j = 25^\circ\text{C}.$

Fig.2 Forward resistance as a function of forward current; typical values.



$f = 1 \text{ MHz}; T_j = 25^\circ\text{C}.$

Fig.3 Diode capacitance as a function of reverse voltage; typical values.

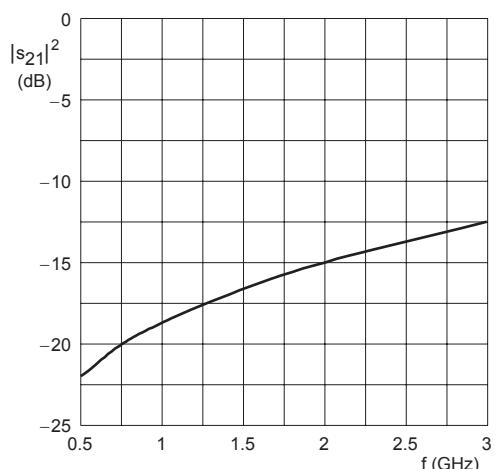


(1) $I_F = 10 \text{ mA}$. (2) $I_F = 1 \text{ mA}$. (3) $I_F = 0.5 \text{ mA}$.

Diode inserted in series with a 50Ω stripline circuit and biased via the analyzer Tee network.

$T_{amb} = 25^\circ\text{C}$.

Fig.4 Insertion loss ($|s_{21}|^2$) of the diode as a function of frequency; typical values.



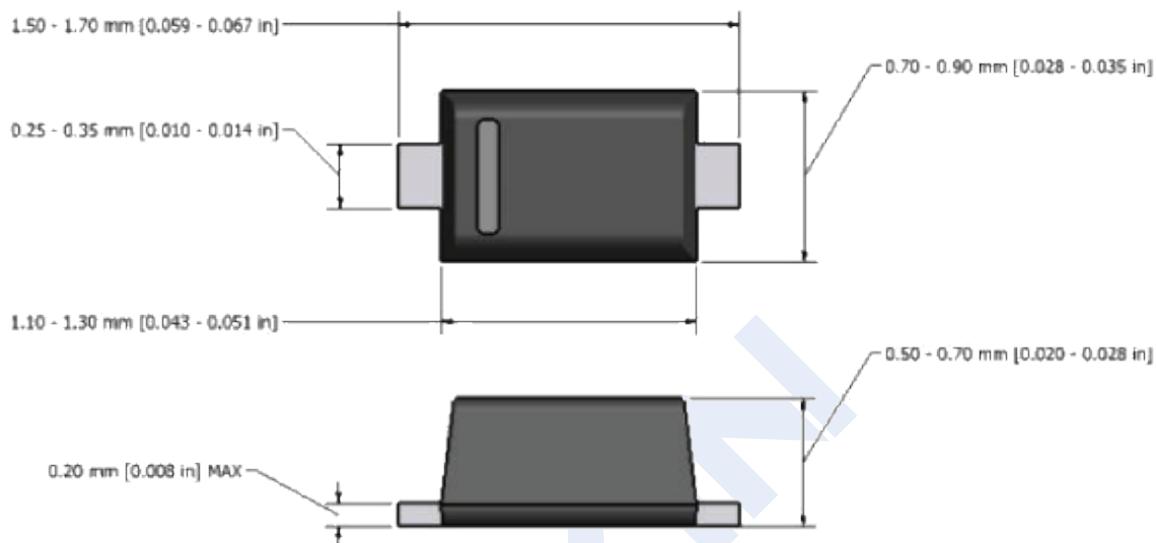
Diode zero biased and inserted in series with a 50Ω stripline circuit. $T_{amb} = 25^\circ\text{C}$.

Fig.5 Isolation ($|s_{21}|^2$) of the diode as a function of frequency; typical values.

General Purpose PIN Diode

BAP51-02

■ Package Outline Dimensions (SOD-523)



Note: Dimensions are exclusive of Burrs, Mold Flash & Tie Bar extrusions.

■ The Recommended Mounting Pad Size

